

PRODUCT NUMBER

73347-Y04LF

PLATING RoHS COMPATIBLE, SEE NOTE 5

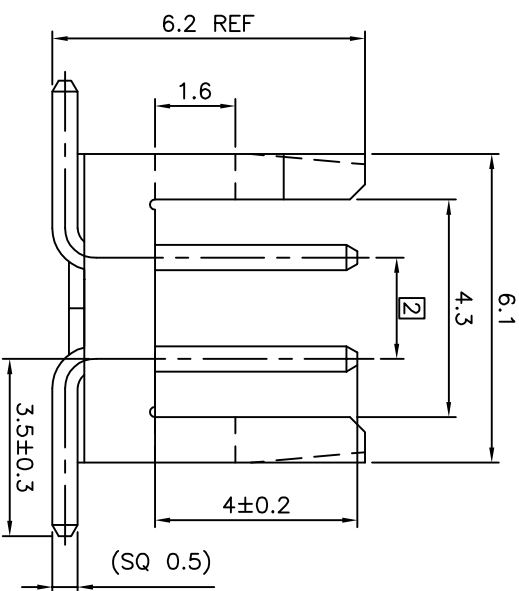
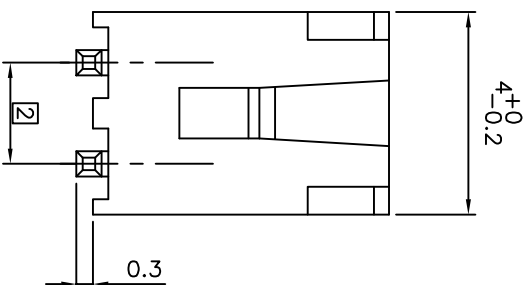
1XX = 0.76µm GOLD/GXT ON CONTACT AREA
2µm MIN MATT TIN ON TAIL

7XXLF = 0.76µm GOLD/GXT FULL PLATED
OVER 1.27µm Ni MIN

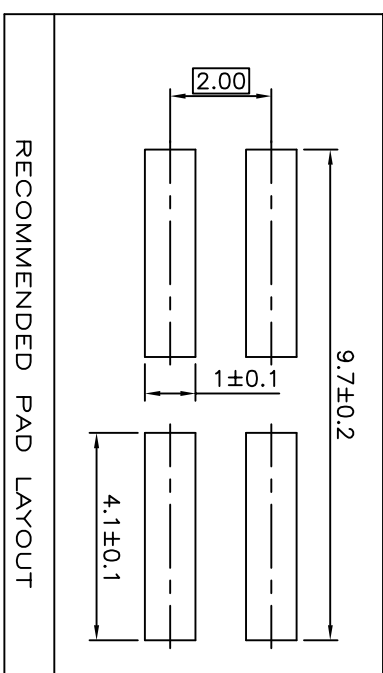
1.27µm MINIMUM NICKEL UNDERPLATE

NOTES :

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR CREAM
2. MATERIAL TERMINAL: COPPER ALLOY
3. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
4. STANDARD PACKAGING IN POLYBAGS:
5. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
 - a - PLATING:
 - "LF" MEANS THE PRODUCT IS LEAD-FREE,
2µm MINIMUM MATTE TIN OVER 1.27µm
MINIMUM NICKEL UNDERPLATE.
 - b - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO
260°C PEAK TEMPERATURE FOR 30 SECONDS
MAX IN A CONVECTION, INFRA-RED OR VAPOR
PHASE OR REFLOW OVEN.
 - c - LABELLING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
 - d - THIS PRODUCT MEETS EUROPEAN DIRECTIVES
AND OTHER COUNTRY REGULATIONS AS DISCRIBED
IN GS-47-0004.
6. PIN POS 1 RECOMMENDED ON THIS SIDE TO MATCH WITH
HOUSING CODING.



NOTE 6



RECOMMENDED PAD LAYOUT

mat'l. code	SEE NOTES	surface	tolerance	projection	product
ecm no	dr date	ISO 1302	ISO 406	ISO 10	family
ecm no	dr date	ISO 1302	ISO 406	ISO 10	MINITEK HEADER
K B-19190	LMU 14.10.24	tolerances unless otherwise specified			title
E F06-0266	LMU 06.08.09	angles	linear	mm	MINITEK
F F07-0191	JCO 07.09.05	dr	JCOMPAGNON	97.11.25	HEADER 2x2
G F08-0143	ELA 15.04.08	engr			dwg no
H F11-0078	LMU 11.06.29	chr			73347
J F12-0018	JCO 12.02.27	appd	JMC	98.03.20	sheet 1 of 1
sheet	revision				A3
index	sheet				CUSTOMER Drawing



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